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FFSB0465A

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

Features

- Max Junction Temperature 175°C
- Avalanche Rated 25 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery
- This Device is Pb–Free, Halogen Free/BFR Free and RoHS Compliant

Applications

- General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuits

ABSOLUTE MAXIMUM RATINGS

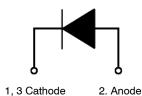
(T_C = 25°C, Unless otherwise specified)

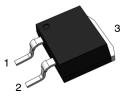
Symbol	Parame	FFSB0465A	Unit		
V _{RRM}	Peak Repetitive Reverse	650	V		
E _{AS}	Single Pulse Avalanche E	25	mJ		
١ _F	Continuous Rectified Forward Current @ $T_C < 160^{\circ}C$		4	А	
	Continuous Rectified For @ T _C < 135°C	7.7			
I _{F, Max}	Non-Repetitive Peak Forward Surge Current	T _C = 25°C, 10 μs	360	Α	
		T _C = 150°C, 10 μs	330		
I _{F, SM}	Non-Repetitive Forward Surge Current	Half–Sine Pulse, t _p = 8.3 ms	38	A	
I _{F, RM}	Repetitive Forward Surge Current	Half–Sine Pulse, t _p = 8.3 ms	18	A	
P _{tot}	Power Dissipation $T_C = 25^{\circ}C$		63	W	
		T _C = 150°C	10.5		
TJ, T _{STG}	Operating and Storage Te	–55 to +175	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. E_{AS} of 25 mJ is based on starting T_J = 25°C, L = 0.5 mH, I_{AS} = 10 A, V = 50 V.

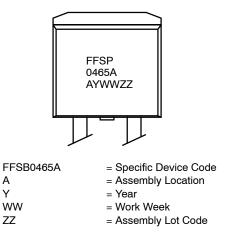
ELECTRICAL CONNECTION





D²PAK2 (TO-263-2L) CASE 418BK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

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THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	2.38	°C/W

ELECTRICAL CHARACTERISTICS $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	r Test Conditions		Тур.	Max.	Unit	
V _F	Forward Voltage	$I_{F} = 4 \text{ A}, \text{ T}_{C} = 25^{\circ}\text{C}$	-	1.50	1.75	V	
		I _F = 4 A, T _C = 125°C	-	1.6	2.0		
		I _F = 4 A, T _C = 175°C	-	1.72	2.4		
I _R	Reverse Current	$V_{R} = 650 \text{ V}, \text{ T}_{C} = 25^{\circ}\text{C}$	-	-	200	μA	
		V _R = 650 V, T _C = 125°C	-	-	400		
		V _R = 650 V, T _C = 175°C	-	-	600		
Q _C	Total Capacitive Charge	V = 400 V	-	16	-	nC	
С	Total Capacitance	V _R = 1 V, f = 100 kHz	-	258	-	pF	
		V _R = 200 V, f = 100 kHz	-	29	-		
		V _R = 400 V, f = 100 kHz	-	21	-		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method†	Reel Size	Tape Width	Quantity
FFSB0465A	FFSB0465A	D2PAK-2L	Tape/Reel	N/A	N/A	800 Units

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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TYPICAL CHARACTERISTICS $T_J = 25^{\circ}C$ UNLESS OTHERWISE NOTED

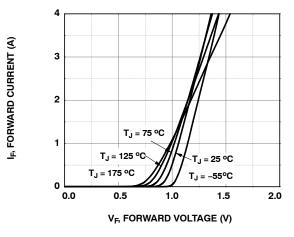


Figure 1. Forward Characteristics

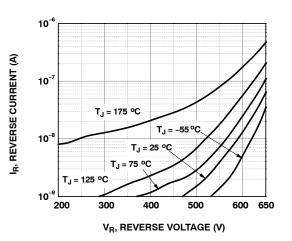


Figure 2. Reverse Characteristics

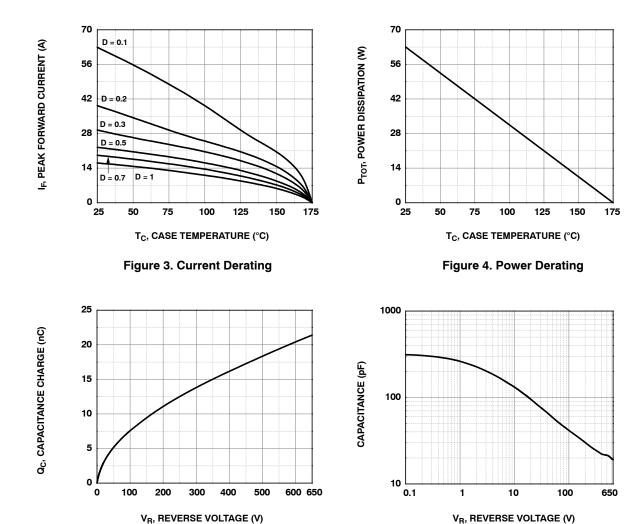
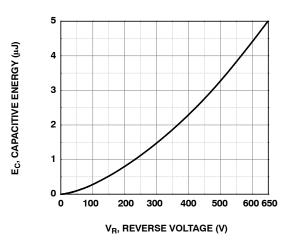


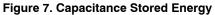


Figure 6. Capacitance vs. Reverse Voltage

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TYPICAL CHARACTERISTICS T_J = 25°C UNLESS OTHERWISE NOTED (CONTINUED)





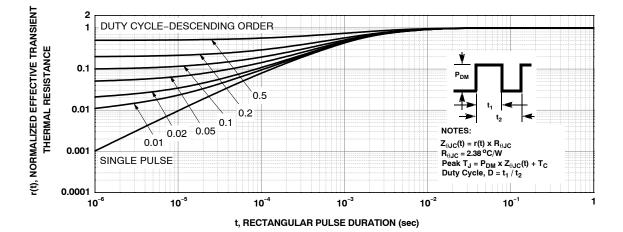
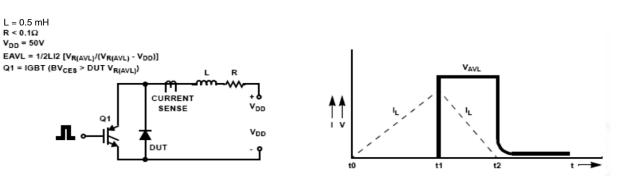


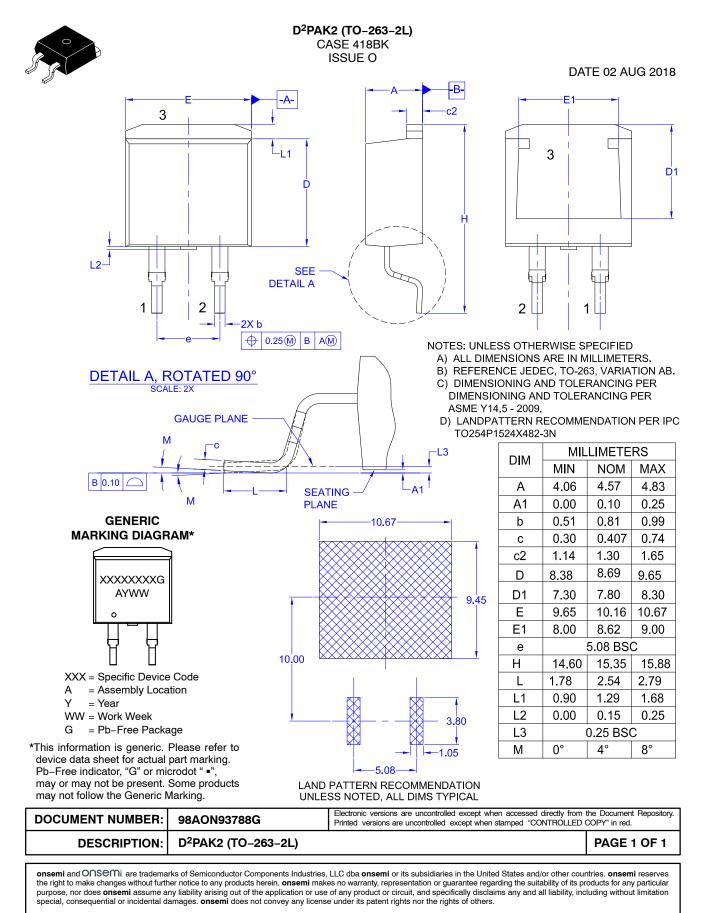
Figure 8. Junction-to-Case Transient Thermal Response Curve



TEST CIRCUIT AND WAVEFORMS

Figure 9. Unclamped Inductive Switching Test Circuit & Waveform

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